

NGTB03N60R2DT4G

IGBT 600V, 4.5A, N-Channel



ON Semiconductor®

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Features

- Reverse Conducting IIGBT
- IGBT $V_{CE(sat)}=1.7V$ (typ) [$I_C=3A$, $V_{GE}=15V$]
- IGBT $t_f=75ns$ (typ)
- Diode $V_F=1.5V$ (typ) [$I_F=3A$]
- Diode $t_{rr}=65ns$ (typ)
- $5\mu s$ Short Circuit Capability

Applications

- General Purpose Inverter

Specifications

Absolute Maximum Ratings at $T_a=25^\circ C$, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector to Emitter Voltage	V_{CES}	600	V
Gate to Emitter Voltage	V_{GES}	± 20	V
Collector Current (DC)	I_C	3	A
Limited by T_{jmax}	I_C^{*1}	4.5	A
Collector Current (Peak)	I_{CP}	12	A
Pulse Limited by T_j			
Diode Average Output Current	I_O	4.5	A
Power Dissipation	P_D	49	W
$T_c=25^\circ C$ in ideal heat dissipation condition ^{*2}			
Junction Temperature	T_j	175	$^\circ C$
Storage Temperature	T_{stg}	-55 to +175	$^\circ C$

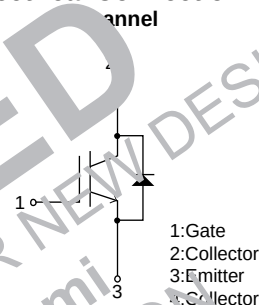
Note : ^{*1} Collector Current is calculated from the following formula.

$$I_C(T_c) = \frac{I_{Cmax} - T_c}{R_{th(j-c)} \times V_{CE(sat)}(I_C(T_c))}$$

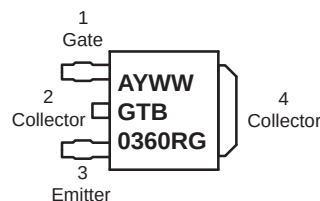
^{*2} Our condition is radiation from backside.

The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminum.

Electrical Connection



Marking Diagram



GTB0360R = Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

NGTB03N60R2DT4G

Electrical Characteristics at Ta=25°C, Unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Collector to Emitter Breakdown Voltage	V(BR)CES	IC=1mA, VGE=0V	600			V
Collector to Emitter Cut off Current	ICES	VCE=600V, VGE=0V			10	μA
					1	mA
Gate to Emitter Leakage Current	IGES	VGE=±20V, VCE=0V			±100	nA
Gate to Emitter Threshold Voltage	VGE(th)	VCE=20V, IC=80μA	4.5		7.0	V
Collector to Emitter Saturation Voltage	VCE(sat)	VGE=15V, IC=3A		1.7	2.1	V
				1.9	2.3	V
Forward Diode Voltage	VF	IF=3A		1.5	2.1	V
Input Capacitance	Cies	VCE=20V, f=1MHz		415		pF
Output Capacitance	Coes			17		pF
Reverse Transfer Capacitance	Cres			10		pF
Turn-ON Delay Time	td(on)	VCC=300V, IC=3A RG=30Ω, L=500μH VGE=0V/15V Vclamp=400V Tc=25°C See Fig.1, See Fig.2		7		ns
Rise Time	tr			1		ns
Turn-ON Time	ton					ns
Turn-OFF Delay Time	td(off)			59		ns
Fall Time	tf			75		ns
Turn-OFF Time	toff			172		ns
Turn-ON Energy	Eon			50		μJ
Turn-OFF Energy	Eoff			27		μJ
Total Gate Charge	Qg			17		nC
Gate to Emitter Charge	Qge			14		nC
Gate to Collector "Miller" Charge	Qgc			7.6		nC
Diode Reverse Recovery Time	trr	di/dt=200A/μs, VCC=300V, See Fig.3		65		ns

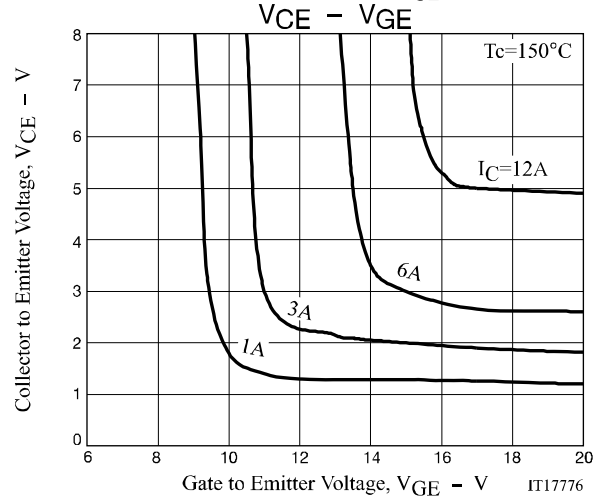
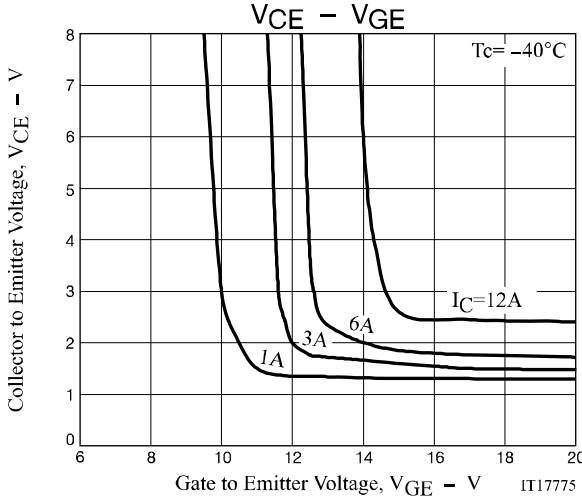
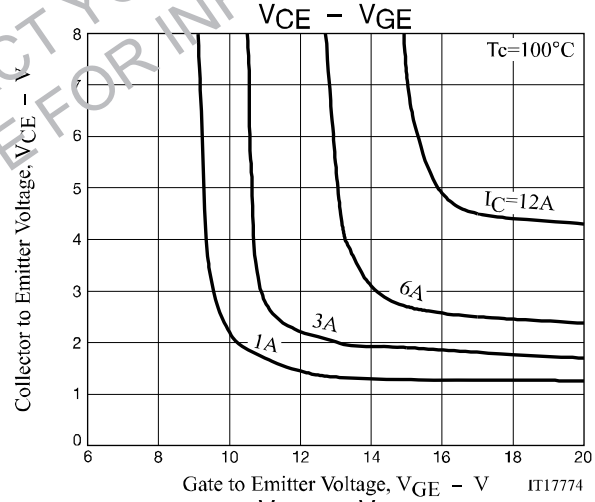
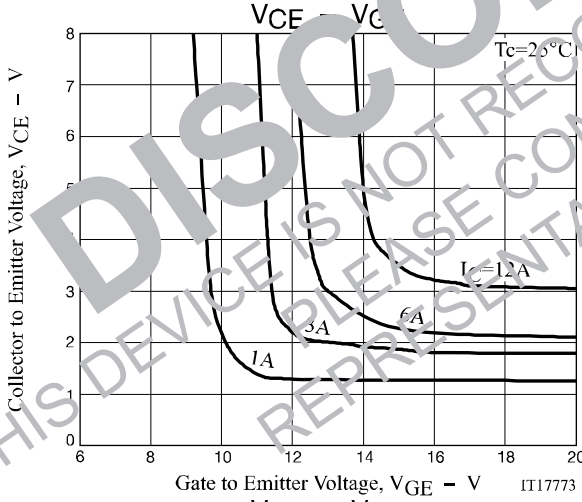
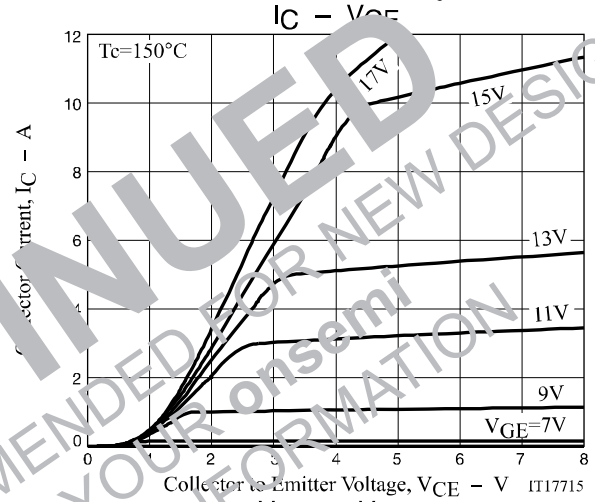
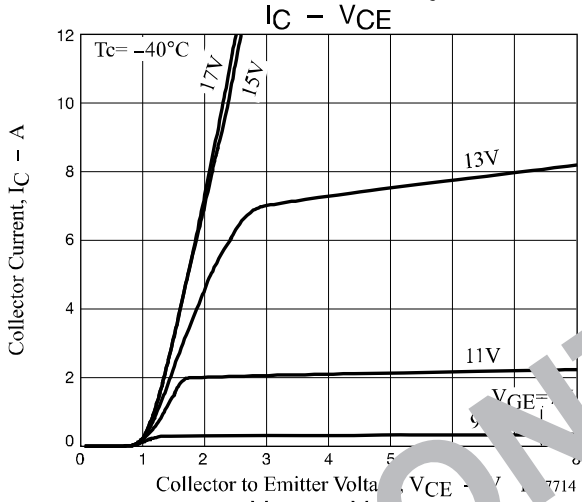
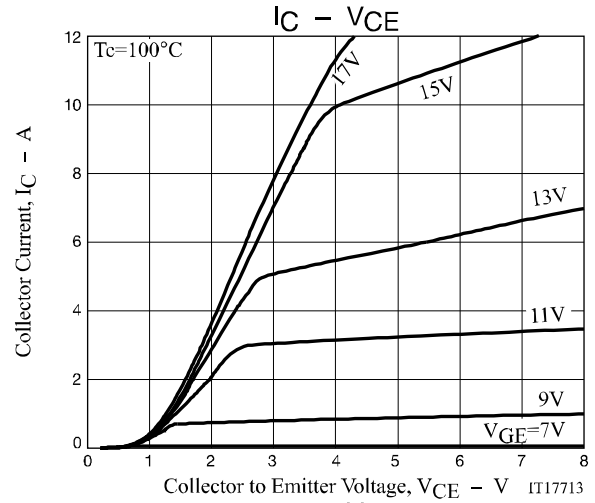
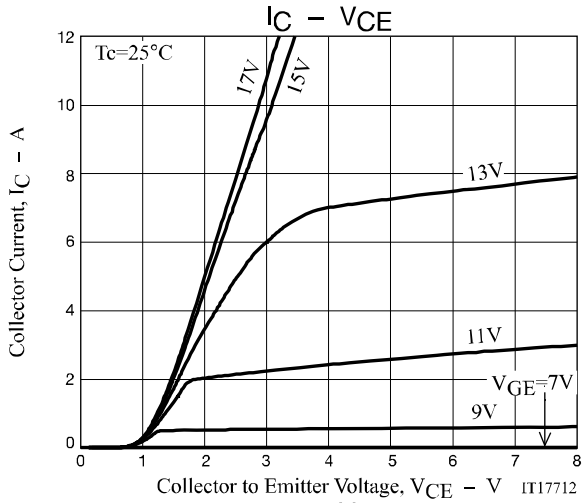
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Thermal Characteristics at Ta=25°C, Unless otherwise specified

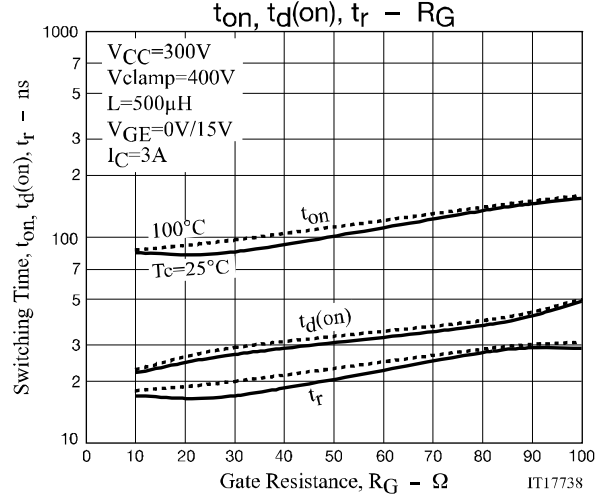
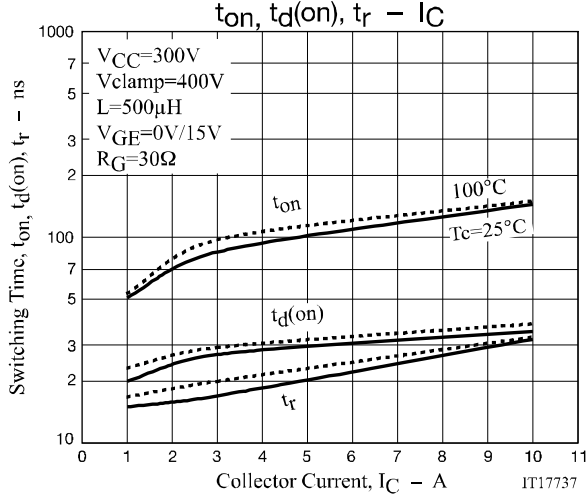
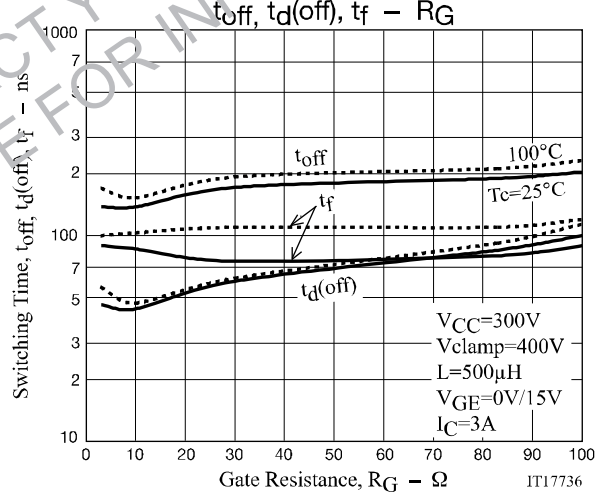
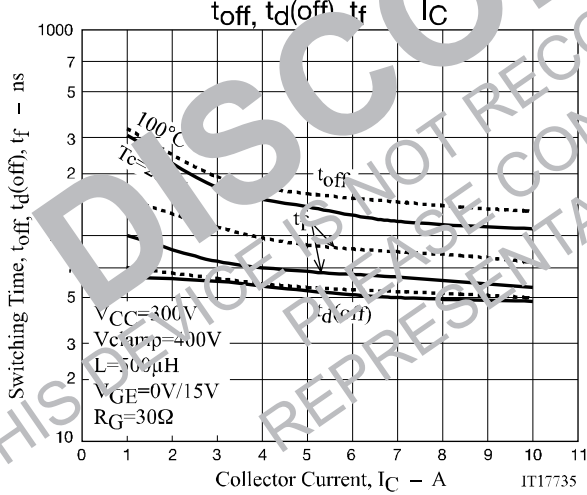
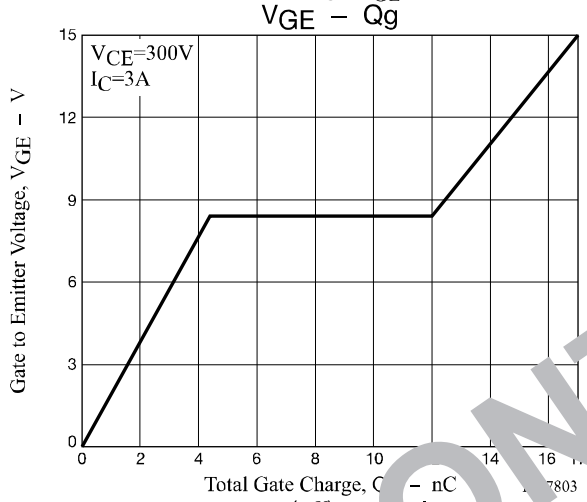
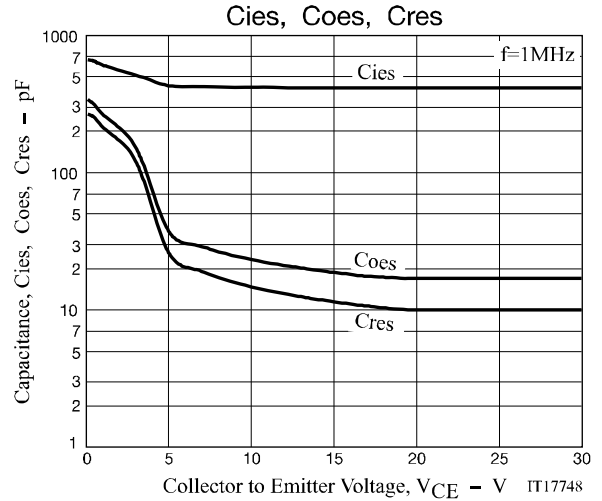
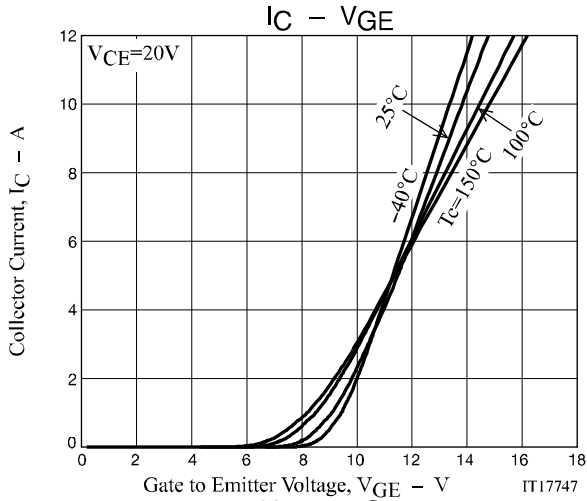
Parameter	Symbol	Conditions	Value	Unit
Thermal Resistance JGB (Junction to Case)	Rth(j-gb)	Tc=25°C (Our ideal heat dissipation condition) *2	3.06	°C/W
Thermal Resistance (Junction to Ambient)	Rth(j-a)		100	°C/W

Note : *2 Our condition is radiation from back side.
The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminum.

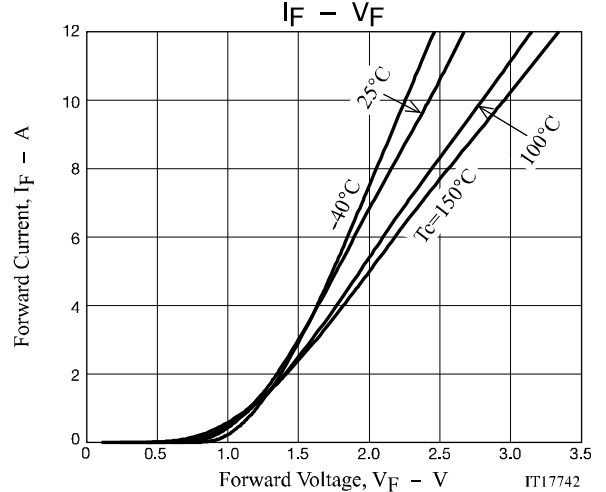
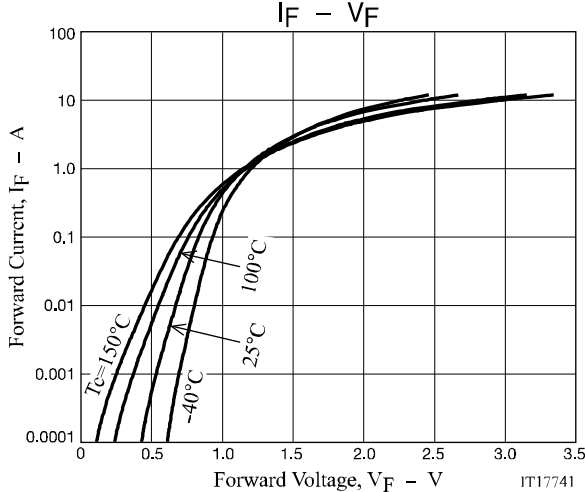
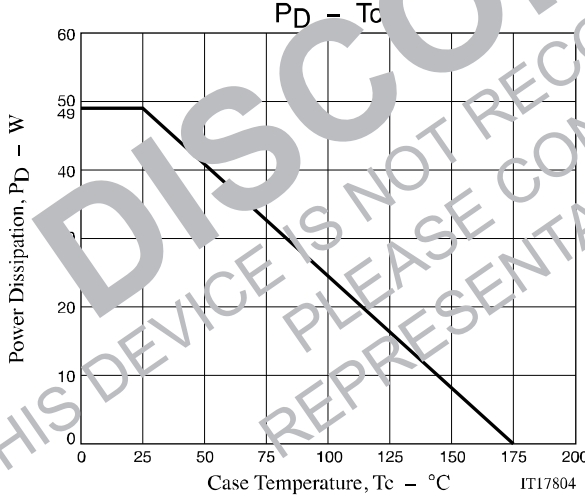
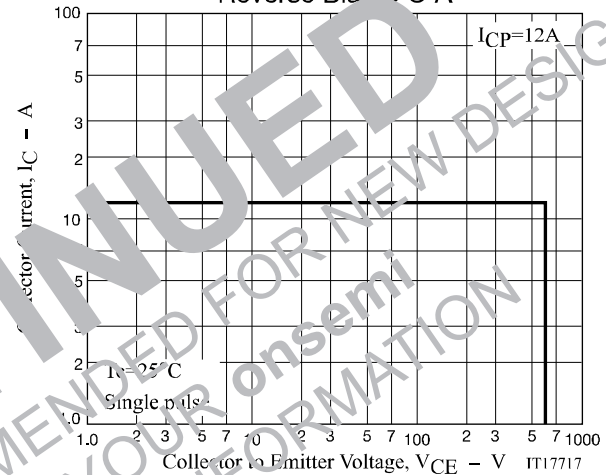
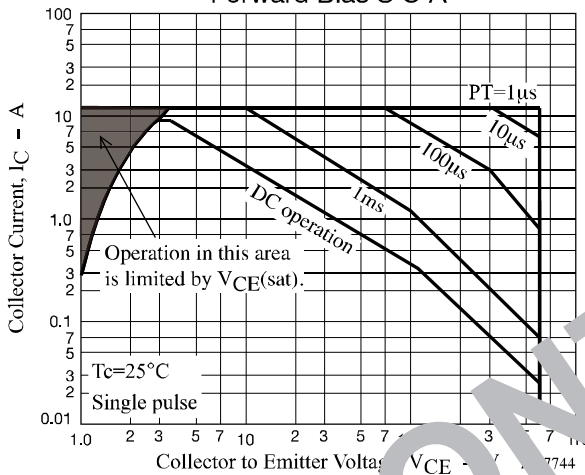
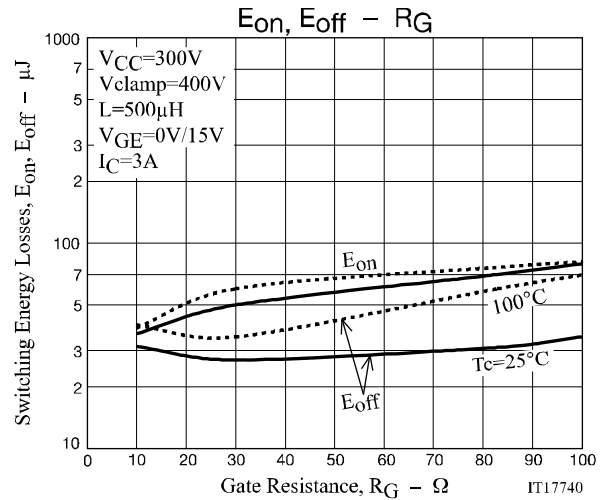
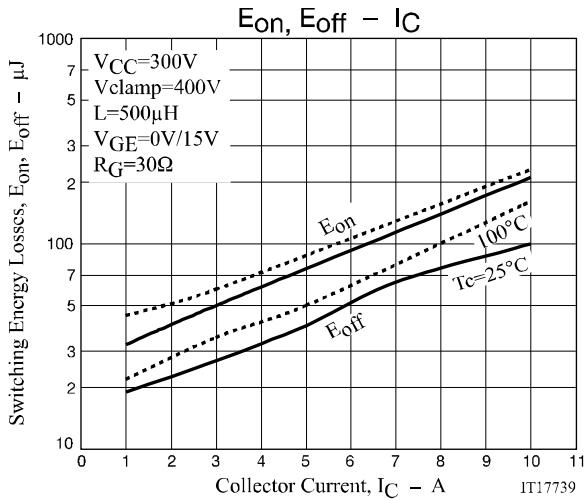
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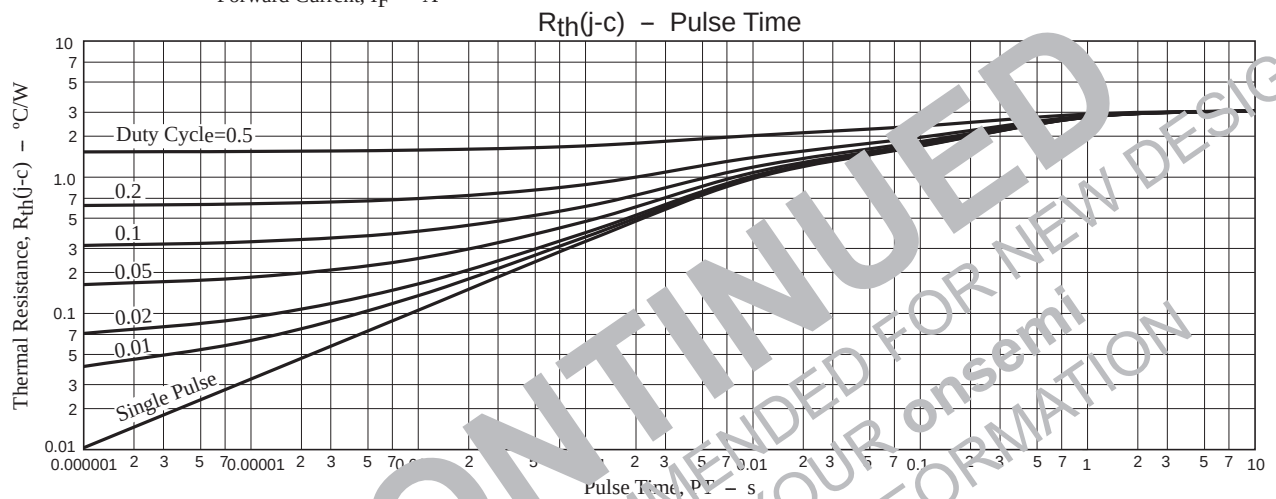
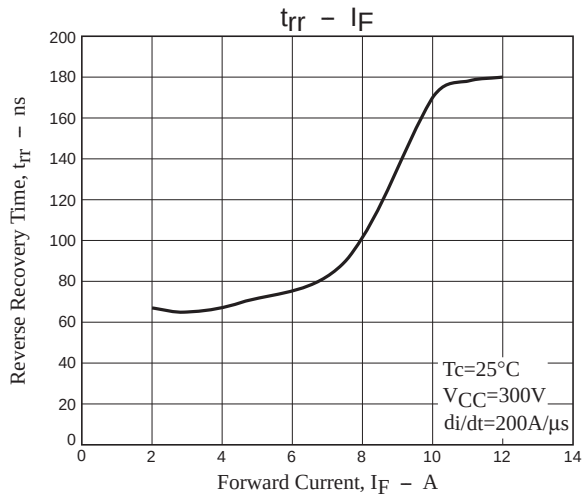


Fig.1 Switching Time Test Circuit

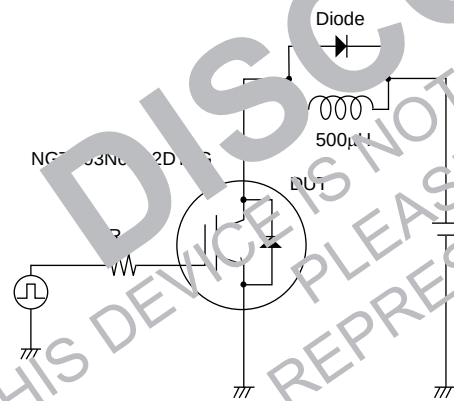


Fig.2 Timing Chart

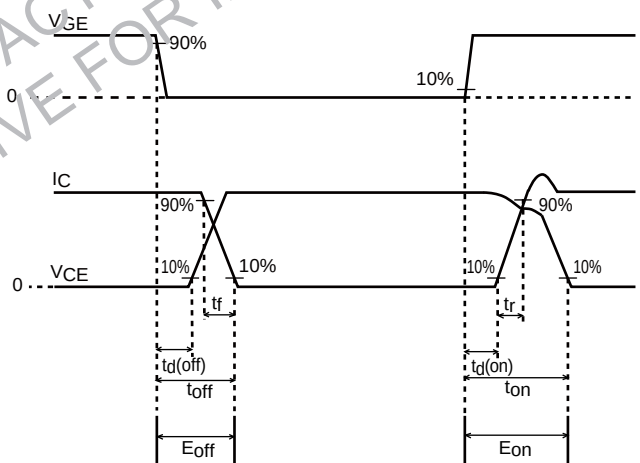
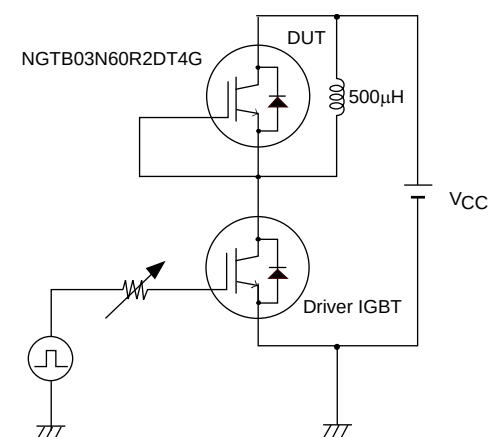


Fig.3 Reverse Recovery Time Test Circuit

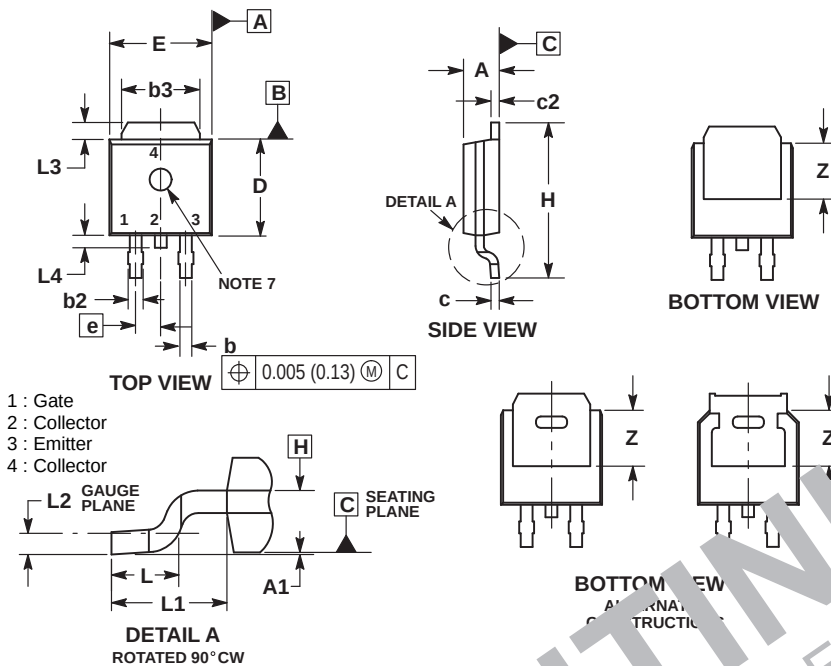


Package Dimensions

DPAK (SINGLE GAUGE)

CASE 369C

ISSUE F

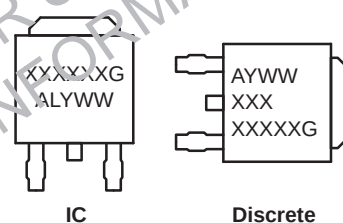


NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: INCHES.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
- DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.
- OPTIONAL MOLD FEATURE:

DIM	MIN	MAX	MIN	MAX
A	0.086	0.091	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.021	0.035	0.53	0.89
b2	0.028	0.045	0.71	1.14
b3	0.180	0.185	4.57	5.46
D	0.013	0.015	0.36	0.61
E	0.013	0.015	0.46	0.61
L	0.235	0.245	5.97	6.22
L1	0.250	0.265	6.35	6.73
L2	0.000	0.000	0.00	0.00
L3	0.370	0.410	9.40	10.41
L4	0.055	0.070	1.40	1.78
L	0.114	REF	2.90	REF
L2	0.020	BSC	0.51	BSC
L3	0.035	0.050	0.89	1.27
L4	0.000	0.000	0.00	0.00
Z	0.155	0.155	3.93	3.93

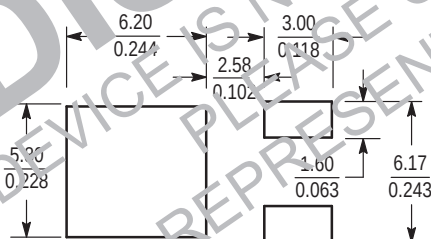
GENERIC MARKING DIAGRAM*



XXXXXX = Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.

SOLDERING FOOTPRINT*



SCALE 3:1 (mm/inches)

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)
NGTB03N60R2DT4G	AYWW GTB 0360RG	DPAK (SINGLE GAUGE) (Pb-Free / Halogen Free)	2500 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

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